



Product Change Notification

112143 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 112143 - 00
Change Title: Intel® Server System R2208LT2HKC4 and R2304LH2HKC
PCN 112143-00, Product Design
Update Power Supply
Date of Publication: March 26, 2013

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Apr 17, 2013
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Description of Change to the Customer:

Intel will implement the following changes on Intel® Server System R2208LT2HKC4 and R2304LH2HKC:

1. The firmware (OpCode) of the 1600W Power Supply has been updated from version 61 to version 64 in order to resolve a random zero watt input reading in the Embedded Web Server interface.
2. The 1600W Power Supply implemented a new latch design that resolves the issue of power supplies potentially not fully seating during insertion of the power supplies into power the supply bay(s).
3. Added a case emboss to the 1600W Power Supply case to eliminate a potential interference issue between the PSU latch and the adjoining PSU case on the H2200/2300 series server chassis. This change is not pertinent to the R2208LT2HKC4 and R2304LH2HKC server chassis.
4. Reduced the PCB thickness of the 1600W Power Supply from 1.60MM to 1.57MM to resolve the issue of power supplies not fully seating into power the supply bay.

Customer Impact of Change and Recommended Action:

Customers may want to perform re-qualification, re-test or standard validation for the updated power supply. However, customers do not need to do a re-certification for the new power supply.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
R2208LT2HKC4	919479	G45890-005	G45890-006
R2304LH2HKC	919482	G46168-005	G46168-006

PCN Revision History:**Date of Revision:**

March 26, 2013

Revision Number:

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Reason:

Originally Published PCN